



**Solid State Devices, Inc.**

14701 Firestone Blvd \* La Mirada, Ca 90638  
 Phone: (562) 404-4474 \* Fax: (562) 404-1773  
 ssdi@ssdi-power.com \* www.ssdi-power.com

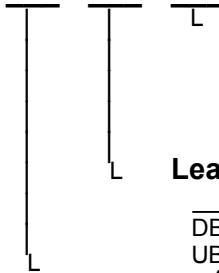
# SFF80N20 Series

## 80 AMP , 200 Volts, 25 mΩ Avalanche Rated N-channel MOSFET

### DESIGNER'S DATA SHEET

#### Part Number / Ordering Information <sup>1/</sup>

**SFF80N20**



#### Screening <sup>2/</sup>

- = Not Screened
- TX = TX Level
- TXV = TXV Level
- S = S Level

#### Lead Option <sup>3/</sup>

- = Straight Leads
- DB = Down Bend
- UB = Up Bend

#### Package <sup>3/ 4/</sup>

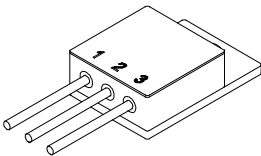
- M = TO-254
- Z = TO-254Z
- N = TO-258
- P = TO-259

#### Features:

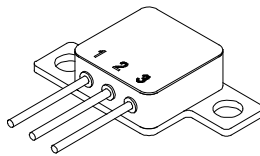
- Rugged poly-Si gate
- Lowest ON-resistance in the industry
- Avalanche rated
- Hermetically Sealed, Isolated Package
- Low Total Gate Charge
- Fast Switching
- TX, TXV, S-Level screening available
- Improved ( $R_{DS(ON)}$ )  $Q_G$  figure of merit

Maximum Ratings <sup>5/</sup>		Symbol	Value	Units
Drain - Source Voltage		$V_{DSS}$	200	V
Gate - Source Voltage	continuous	$V_{GS}$	±20	V
	transient		±30	
Max. Continuous Drain Current (package limited)	@ $T_C = 25^\circ C$	$I_{D1}$	55	A
Max. Instantaneous Drain Current ( $T_j$ limited)	@ $T_C = 25^\circ C$	$I_{D2}$	80	A
	@ $T_C = 175^\circ C$	$I_{D3}$	48	
Max. Avalanche current	@ $L = 0.1$ mH	$I_{AR}$	60	A
Single and Repetitive Avalanche Energy	@ $L = 0.1$ mH	$E_{AS}$	1500	mJ
		$E_{AR}$	50	
Total Power Dissipation	@ $T_C = 25^\circ C$	$P_D$	150	W
Operating & Storage Temperature		$T_{OP}$ & $T_{STG}$	-55 to +175	$^\circ C$
Maximum Thermal Resistance (Junction to Case)		$R_{\theta JC}$	1.0 (typ.0.75)	$^\circ C/W$

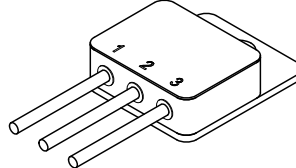
TO-254 (M)



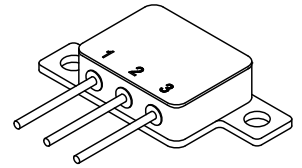
TO-254Z (Z)



TO-258 (N)



TO-259 (P)



#### NOTES:

- \*Pulse Test: Pulse Width = 300µsec, Duty Cycle = 2%.
- 1/ For ordering information, price, and availability - contact factory.
- 2/ Screening based on MIL-PRF-19500. Screening flows available on request.
- 3/ For lead bending options / pinout configurations - contact factory.
- 4/ Maximum current limited by package configuration
- 5/ Unless otherwise specified, all electrical characteristics @25°C.

**NOTE:** All specifications are subject to change without notification.  
 SCD's for these devices should be reviewed by SSDI prior to release.

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Electrical Characteristics <sup>5/</sup>	Symbol	Min	Typ	Max	Units	
Drain to Source Breakdown Voltage $V_{GS} = 0V, I_D = 250\mu A$	$BV_{DSS}$	200	220	—	V	
Drain to Source On State Resistance $V_{GS} = 10V, I_D = 48A, T_j = 25^\circ C$ $V_{GS} = 10V, I_D = 48A, T_j = 125^\circ C$ $V_{GS} = 10V, I_D = 48A, T_j = 175^\circ C$	$R_{DS(on)}$	—	25 50 65	30 65 —	m $\Omega$	
Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = 4.0mA, T_j = 25^\circ C$ $V_{DS} = V_{GS}, I_D = 4.0mA, T_j = 125^\circ C$ $V_{DS} = V_{GS}, I_D = 4.0mA, T_j = -55^\circ C$	$V_{GS(th)}$	2.5 1.5 —	4.5 3.6 5	5.0 — 6	V	
Gate to Source Leakage $V_{GS} = \pm 20V, T_j = 25^\circ C$ $V_{GS} = \pm 20V, T_j = 125^\circ C$	$I_{GSS}$	—	10 30	$\pm 100$ —	nA	
Zero Gate Voltage Drain Current $V_{DS} = 200V, V_{GS} = 0V, T_j = 25^\circ C$ $V_{DS} = 200V, V_{GS} = 0V, T_j = 125^\circ C$ $V_{DS} = 200V, V_{GS} = 0V, T_j = 150^\circ C$	$I_{DSS}$	—	0.01 2.5 25	25 150 —	$\mu A$ $\mu A$ $\mu A$	
Forward Transconductance $V_{DS} = 10V, I_D = 48A, T_j = 25^\circ C$	$g_{fs}$	25	50	—	Mho	
Total Gate Charge $V_{GS} = 10V$	$Q_g$	—	150	250	nC	
Gate to Source Charge $V_{DS} = 100V$	$Q_{gs}$	—	45	65	nC	
Gate to Drain Charge $I_D = 48A$	$Q_{gd}$	—	75	120		
Turn on Delay Time $V_{GS} = 10V$	$t_{d(on)}$	—	50	75	nsec	
Rise Time $V_{DS} = 100V$	$t_r$	—	50	75		
Turn off Delay Time $I_D = 48A$	$t_{d(off)}$	—	110	135		
Fall Time $R_G = 4.0\Omega, pw = 3\mu s$	$t_f$	—	50	75		
Diode Forward Voltage $I_F = 48A, V_{GS} = 0V$	$V_{SD}$	—	0.90	1.5	V	
Diode Reverse Recovery Time Reverse Recovery Charge	$I_F = 10A, di/dt = 100A/\mu s$	$t_{rr1}$	—	190	250	nsec
	$I_F = 10A, di/dt = 100A/\mu s$	$I_{rm1}$	—	11	—	A
	$I_F = 10A, di/dt = 100A/\mu s$	$Q_{rr1}$	—	1	—	$\mu C$
	$I_F = 25A, di/dt = 100A/\mu s$	$t_{rr2}$	—	310	—	nsec
	$I_F = 25A, di/dt = 100A/\mu s$	$I_{rm2}$	—	17	—	A
	$I_F = 25A, di/dt = 100A/\mu s$	$Q_{rr2}$	—	2.5	—	$\mu C$
Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1 MHz$	$C_{iss}$ $C_{oss}$ $C_{rss}$	— — —	5300 1050 175	— — —	pF

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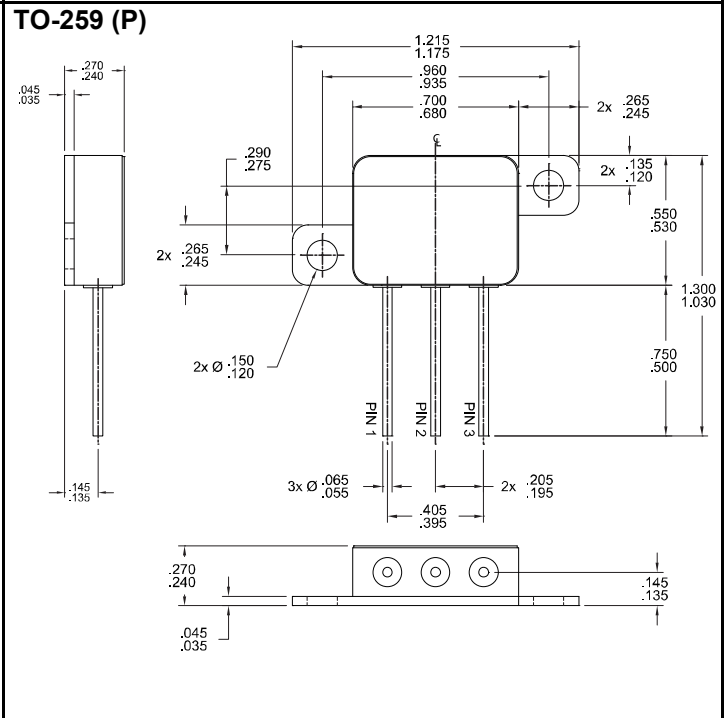
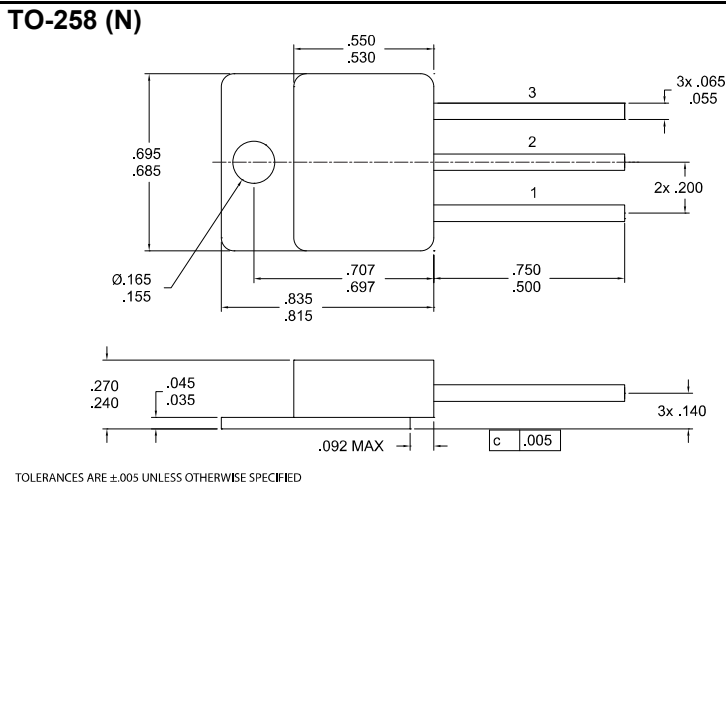
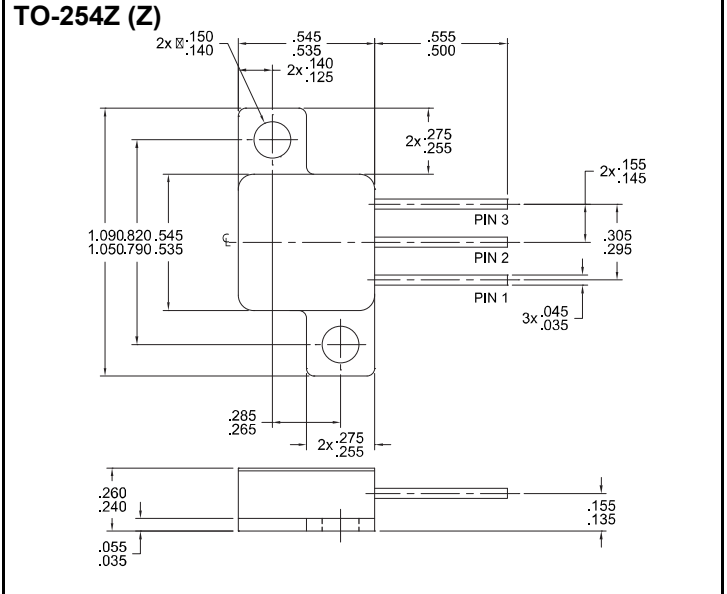
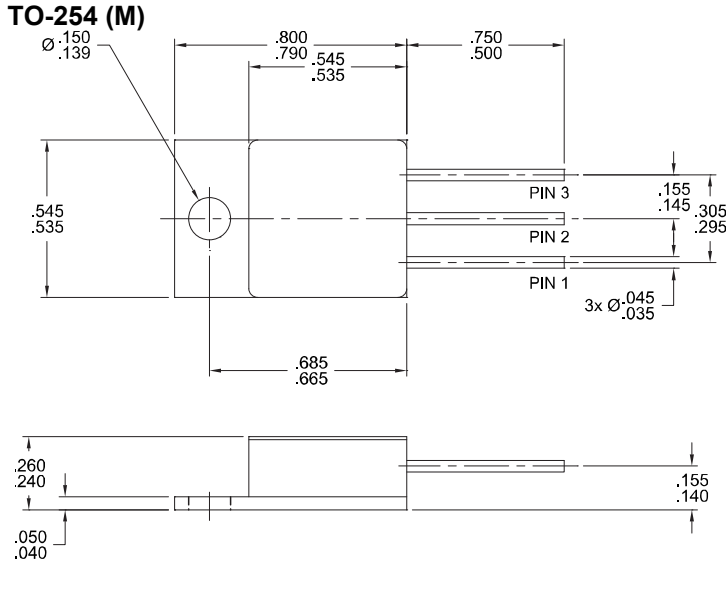
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**PIN ASSIGNMENT (Standard)**

Package	Drain	Source	Gate
TO-254 (M)	Pin 1	Pin 2	Pin 3
TO-254Z (Z)	Pin 1	Pin 2	Pin 3
TO-258 (N)	Pin 1	Pin 2	Pin 3
TO-259 (P)	Pin 1	Pin 2	Pin 3

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